

## 115-43-320-41-001000

#### 115-43-320-41-001000 Information



## **Certified Quality**

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.



### 115-43-320-41-001000 Specifications

Manufacturer Mill-Max Manufacturing Corp.   Connectors, Interconnects Sockets for ICs, Transistors   Package -   Package 115   Species DIP, 0.3" (7.62mm) Row Spacing   Number of Positions or Pins (Grid) 20 (2 x 10)   Pitch - Mating 0.100" (2.54mm)   Contact Finish - Mating Gold   Contact Finish - Mating 30µin (0.76µm)   Contact Finish - Mating Beryllium Copper   Contact Material - Mating Open Frame   Perunination Solder   Contact Finish - Post 0.100" (2.54mm)   Contact Finish - Post Open Frame   Contact Material - Mating Solder   Perunination Solder   Contact Finish - Post 0.100" (2.54mm)   Contact Finish - Post Open Frame   Contact Finish Thickness - Post Solder   Contact Finish Thickness - Post Solduring (0.54µm)   Contact Finish Thickness - Post Solphin (5.08µm)   Contact Finish Thickness - Post Solphin (5.08µm)   Contact Material - Post Brass Alloy			
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Fype DIP, 0.3" (7.62mm) Row Spacing   Number of Positions or Pins (Grid) 20 (2 x 10)   Pitch - Mating 0.100" (2.54mm)   Contact Finish - Mating Gold   Contact Finish Thickness - Mating 30µin (0.76µm)   Contact Finish Thickness - Mating Beryllium Copper   Contact Material - Mating Beryllium Copper   Mounting Type Through Hole   Features Open Frame   Pitch - Post 0.100" (2.54mm)   Contact Finish Thickness - Post Solder   Contact Finish Thickness - Post 0.100" (2.54mm)   Contact Finish Thickness - Post 20µin (5.08µm)   Contact Finish Thickness - Post 20µin (5.08µm)   Contact Material - Post Brass Alloy   Housing Material Polycyclohexylenedimethylene Terephthalate (PCT), Polyester   Operating Temperature -55°C ~ 125°C	Package	-	
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Housing MaterialPolycyclohexylenedimethylene Terephthalate (PCT), PolyesterOperating Temperature-55°C ~ 125°C	Contact Finish Thickness - Post	200µin (5.08µm)	
Operating Temperature $-55^{\circ}C \sim 125^{\circ}C$	Contact Material - Post	Brass Alloy	
	Housing Material	Polycyclohexylenedimethylene Terephthalate (PCT), Polyester	
Report errors?	Operating Temperature	-55°C ~ 125°C	
			Report errors?

#### 115-43-320-41-001000 Guarantees



**Quality Guarantees** 

We provide 90 days warranty. \* If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.

# SERVICE BUARANTEE

#### **Service Guarantees**

We guarantee 100% customer satisfaction. Our experienced sales team and tech support team back our services to satisfy all our customers.

## 115-43-320-41-001000 Payment Methods





If you have any question about 115-43-320-41-001000, please do not hesitate to contact us! Website: https://www.heisener.com E-mail: salesdept@heisener.com